

# Customer Information Notification

Issue Date: 15-Jul-2020 Effective Date: 16-Jul-2020 Dear Emma Tempest,

Here's your personalized quality information concerning products Premier Farnell PLC purchased from NXP. For detailed information we invite you to <u>view this</u> notification online

### This notice is NXP Company Proprietary.

# 2020060181



# QUALITY

## Change Category

[] Wafer Fab Process [] Assembly[] Product Marking [] Test [] Design Process Location [] Wafer Fab Materials [] Assembly[] Mechanical []Test [] Errata Specification Materials Process [] Wafer Fab Location [] Assembly[] []Test [] Electrical Packing/Shipping/Labeling Equipment spec./Test Location coverage [X] Other - Reference Manual and Datasheet [] Firmware MC9S12ZVC- Family **Reference Manual and** Datasheet Update to Rev

#### Description

2.2

NXP Semiconductors announces reference manual and datasheet update for MC9S12ZVC family from revision 2.1 to revision 2.2. The revision history included in the updated document provides a details description of the changes.

Changes in the document includes:

- Mask Set 1N23N was added to portfolio to address an OEM specific shunt test
- Updated Table 1-4 (added part IDs for mask set 1N23N)
- Updated Table I-2 (Num 1: CAN transceiver current)
- Updated Table A-8 (Num 7 and 16: NGPIO leakage current)

The MC9S12ZVC family reference manual and datasheet revision 2.2 is attached to this notification and can be found at:

https://www.nxp.com/products/processors-and-microcontrollers/additional-architectures/s12-magnivmixed-signal-mcus/s12zvc-mixed-signal-mcu-for-automotive-industrial-canapplications:S12ZVC?tab=Documentation Tab

Corresponding ZVEI Delta Qualification Matrix ID: SEM-DS-02 and SEM-DS-03. **Reason** The reference manual and datasheet have been updated to provide additional technical clarification. **Identification of Affected Products** 

Product identification does not change

Product identification does not change

#### Anticipated Impact on Form, Fit, Function, Reliability or Quality

No impact on form, fit, function, reliability or quality.

#### Data Sheet Revision

A new datasheet will be issued

#### Additional information

Affected products and sales history information: see attached file

Additional documents: view online

#### **Contact and Support**

For all inquiries regarding the ePCN tool application or access issues, please <u>contact NXP "Global Quality</u> Support Team".

For all Quality Notification content inquiries, please contact your local NXP Sales Support team.

For specific questions on this notice or the products affected please contact our specialist directly: Name NXP Technical Support

e-mail address tech.support@nxp.com

At NXP Semiconductors we are constantly striving to improve our product and processes to ensure they reach the highest possible Quality Standards.

Customer Focus, Passion to Win.

NXP Quality Management Team.

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NXP Semiconductors N.V. (NASDAQ: NXPI) provides High Performance Mixed Signal and Standard Product solutions that leverage its leading RF, Analog, Power Management, Interface, Security and Digital Processing expertise. These innovations are used in a wide range of automotive, identification, wireless infrastructure, lighting, industrial, mobile, consumer and computing applications.

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